


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	Heat Sink Fan and Method for Manufacturing Heat Sink That Is Used For the Heat Sink Fan		
Application Type :		regular, utility	
Attorney Docket Number :		18.017-AG	
Correspondence address:			
Customer Number:		29453	
Priority Data:			
Doc.No: 2003-435730; Country -JP ; Date: 2003-12-26 us-priority-claimed			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Assignee 1:

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